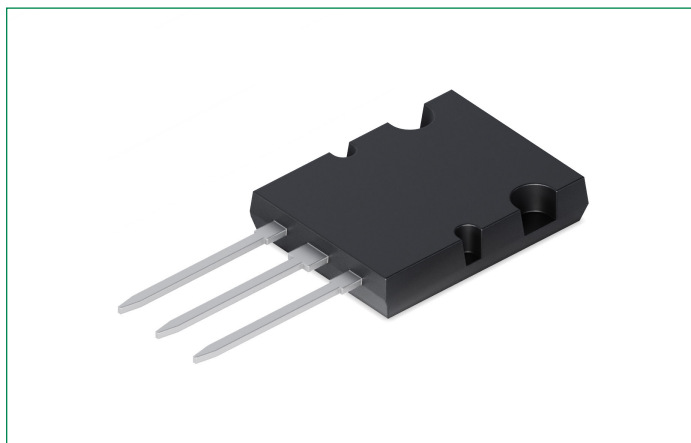


IXFB44N100P

1000 V, 220 m Ω Polar™ HiPerFET™ Power MOSFET

N-Channel Enhancement Mode



Features:

- Unclamped Inductive Switching (UIS) Rated
- Low Package Inductance
 - Easy to Drive and to Protect
- N-Channel Enhancement Mode
- Fast Intrinsic Rectifier
- Avalanche Rated
- Low $R_{DS(on)}$ and Q_G

Advantages:

- Plus 264™ Package for Clip or Spring Mounting
- Space Savings
- High Power Density

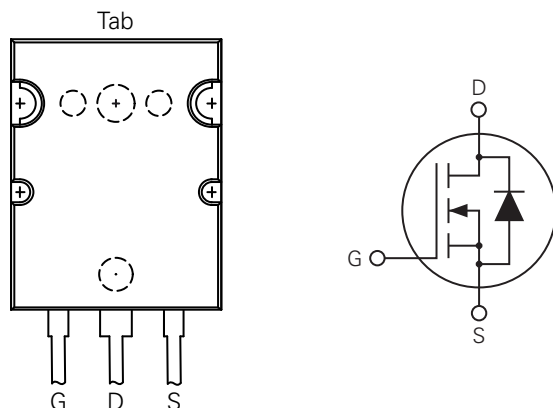
Applications:

- Switched-Mode and Resonant-Mode Power Supplies
- DC-DC Converters
- Laser Drivers
- AC and DC Motor Controls
- Robotics and Servo Controls

Product Summary

Characteristic	Value	Unit
V_{DSS}	1000	V
I_{D25}	44	A
$R_{DS(on)}$	220	Ω
t_{rr}	300	ns

Pinout Diagram (PLUS TO-264)



G: Gate; **D:** Drain; **S:** Emitter; **Tab:** Drain

Maximum Ratings

Symbol	Characteristics	Conditions	Value	Units
V_{DSS}	Drain-Source Voltage	$T_J = 25^{\circ}\text{C}$ to 150°C	1000	V
V_{DGR}	Drain-Gate Voltage	$T_J = 25^{\circ}\text{C}$ to 150°C , $R_{GS} = 1\text{ M}\Omega$	1000	V
V_{GSS}	Gate-Source Voltage	Continuous	± 30	V
V_{GSM}		Transient	± 40	
I_{D25}	Drain Current	$T_C = 25^{\circ}\text{C}$	44	A
I_{DM}		$T_C = 25^{\circ}\text{C}$, Pulse width limited by T_{JM}	110	
I_{AR}	Avalanche Current	$T_C = 25^{\circ}\text{C}$	22	A
E_{AS}	Avalanche Energy	$T_C = 25^{\circ}\text{C}$	2	J
dV/dt	Reverse Diode dV/dt	$I_S \leq I_{DM}$, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^{\circ}\text{C}$	15	V/ns
P_D	Power Dissipation	$T_C = 25^{\circ}\text{C}$	1250	W
T_J	Operating Junction Temperature	–	-55 to +150	$^{\circ}\text{C}$
T_{JM}	Maximum Junction Temperature	–	150	
T_{stg}	Storage Temperature	–	-55 to +150	
T_L	Lead Temperature for Soldering	1.6 mm (0.062 in.) from case for 10 s	300	$^{\circ}\text{C}$
F_C	Mounting Force	–	30..120 / 6.7..27	N/lb
W	Weight	–	10	g

Thermal Characteristics

Symbol	Characteristic	Value			Unit
		Min.	Typ.	Max.	
$R_{th, JC}$	Thermal Resistance, junction-to-case	–	–	0.10	$^{\circ}\text{C}/\text{W}$
$R_{th, CS}$	Thermal Resistance, case-to-sink	–	0.13	–	$^{\circ}\text{C}/\text{W}$

Electrical Characteristics – Static ($T_J = 25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Characteristic	Conditions	Value			Unit
			Min.	Typ.	Max.	
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 3\text{ mA}$, $V_{GS} = 0\text{ V}$	1000	–	–	V
$V_{GS(th)}$	Gate Threshold Voltage	$I_D = 1\text{ mA}$, $V_{DS} = V_{GS}$	3.5	–	6.5	V
I_{GSS}	Gate-Source Leakage Current	$V_{DS} = 0\text{ V}$, $V_{GS} = \pm 30\text{ V}$	–	–	± 200	nA
I_{DSS}	Drain-Source Current	$V_{DS} = V_{DSS}$, $V_{GS} = 0\text{ V}$	–	–	50	μA
		$V_{DS} = V_{DSS}$, $V_{GS} = 0\text{ V}$, $T_J = 125^{\circ}\text{C}$	–	–	3	mA
$R_{DS(on)}$	Drain-Source On-Resistance ¹	$V_{GS} = 10\text{ V}$, $I_D = 0.5 \times I_{D25}$	–	–	220	m Ω

Note 1: Pulse test, $t \leq 300\text{ }\mu\text{s}$, duty cycle, $d \leq 2\%$

Electrical Characteristics – Dynamic ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Conditions	Value			Unit
			Min.	Typ.	Max.	
g_{fs}	Transconductance ¹	$V_{DS} = 20\text{ V}, I_D = 0.5 \times I_{D25}$	20	35	–	S
R_{Gi}	Gate Input Resistance	–	–	1.4	–	Ω
C_{iss}	Input Capacitance	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	–	16.9	–	nF
C_{oss}	Output Capacitance		–	1100	–	pF
C_{rss}	Reverse Transfer Capacitance		–	184	–	pF
$Q_{g(on)}$	Total Gate Charge	$V_{GS} = 10\text{ V}, V_{DS} = 0.5 \times V_{DSS},$ $I_D = 0.5 \times I_{D25}$	–	305	–	nC
Q_{gs}	Gate-Source Charge		–	104	–	
Q_{gd}	Gate-Drain Charge		–	126	–	
$t_{d(on)}$	Turn-on Delay Time	Resistive Switching $V_{GS} = 10\text{ V}, V_{DS} = 0.5 \times V_{DSS},$ $I_D = 0.5 \times I_{D25}, R_{G(ext)} = 1\ \Omega$	–	60	–	ns
t_r	Rise Time		–	68	–	
$t_{d(off)}$	Turn-off Delay Time		–	90	–	
t_f	Fall Time		–	56	–	

Note 1: Pulse test, $t \leq 300\ \mu\text{s}$, duty cycle, $d \leq 2\%$

Source-Drain Diode Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Conditions	Value			Unit
			Min.	Typ.	Max.	
I_S	Continuous Diode Forward Current	$V_{GS} = 0\text{ V}$	–	–	44	A
I_{SM}	Diode Pulse Current	Repetitive, Pulse width limited by T_{JM}	–	–	176	A
V_{SD}	Diode Forward Voltage ¹	$I_F = I_S, V_{GS} = 0\text{ V}$	–	–	1.5	V
t_{rr}	Reverse Recovery Time	$I_F = 22\text{ A}, -di/dt = 100\text{ A}/\mu\text{s},$ $V_r = 100\text{ V}$	–	–	300	ns
Q_{rm}	Reverse Recovery Charge		–	2.5	–	μC
I_{rm}	Reverse Recovery Current		–	17.0	–	A

Note 1: Pulse test, $t \leq 300\ \mu\text{s}$, duty cycle, $d \leq 2\%$

Characteristic Curves

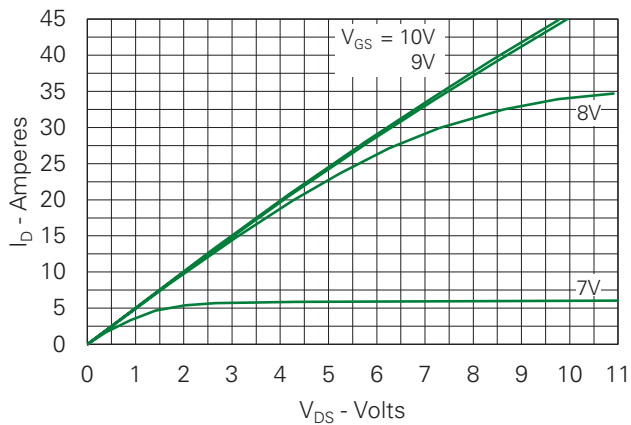
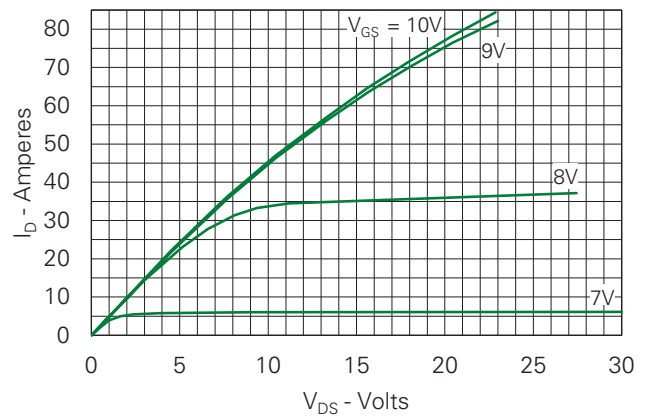
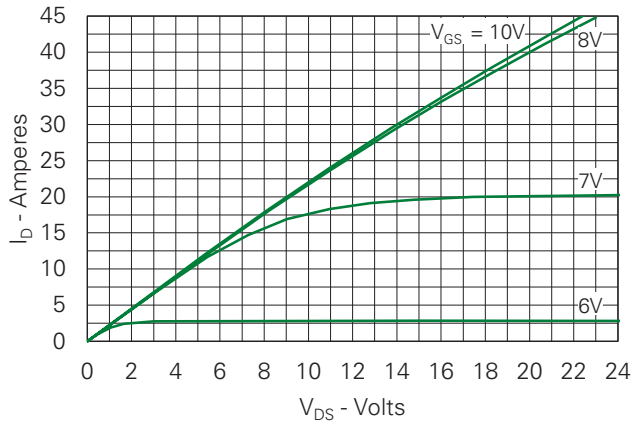
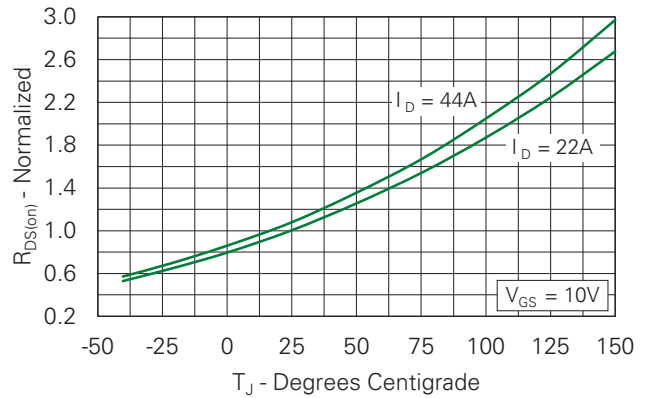
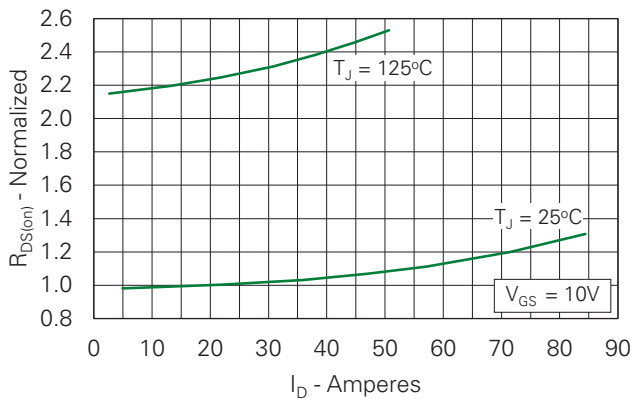
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$ Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$ Fig. 3. Output Characteristics @ $T_J = 125^\circ\text{C}$ Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 22\text{A}$ Value vs. Junction TemperatureFig. 5. $R_{DS(on)}$ Normalized to $I_D = 22\text{A}$ Value vs. Drain Current

Fig. 6. Maximum Drain Current vs. Case Temperature

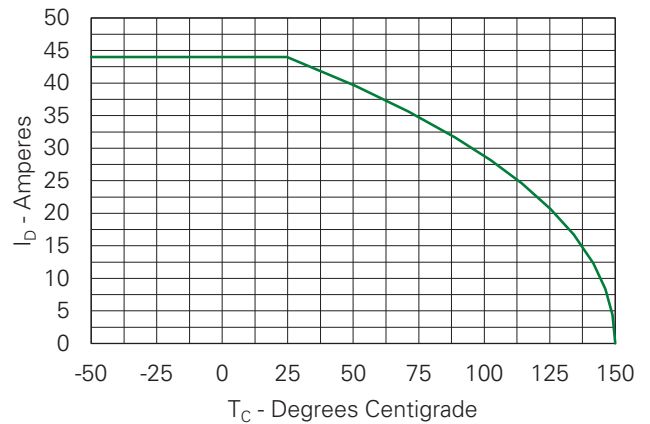


Fig. 7. Input Admittance

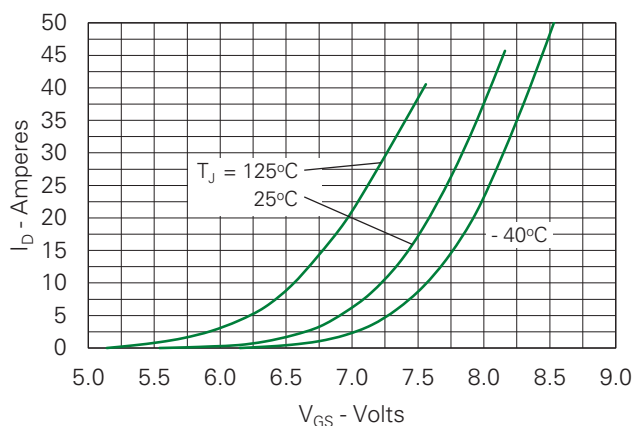


Fig. 8. Transconductance

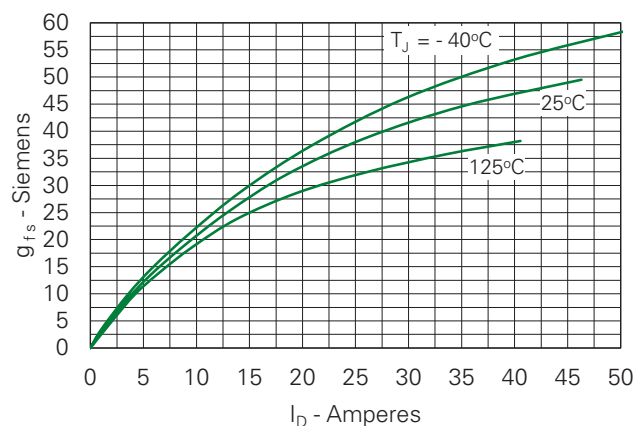


Fig. 9. Forward Voltage Drop of Intrinsic Diode

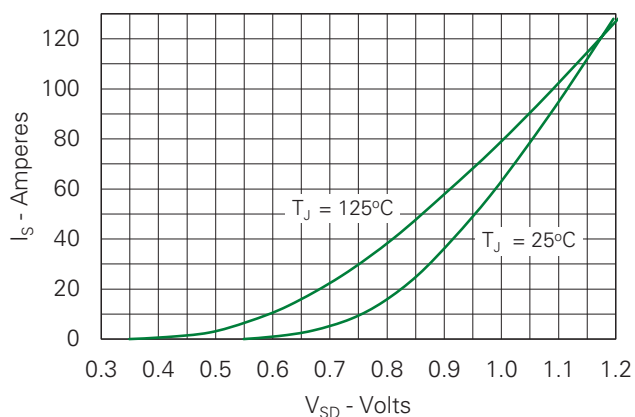


Fig. 10. Gate Charge

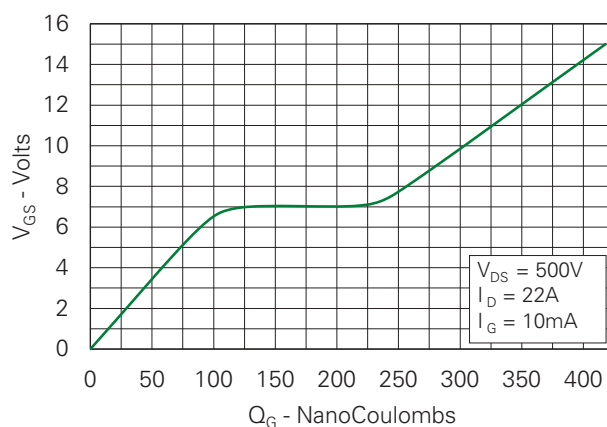


Fig. 11. Capacitance

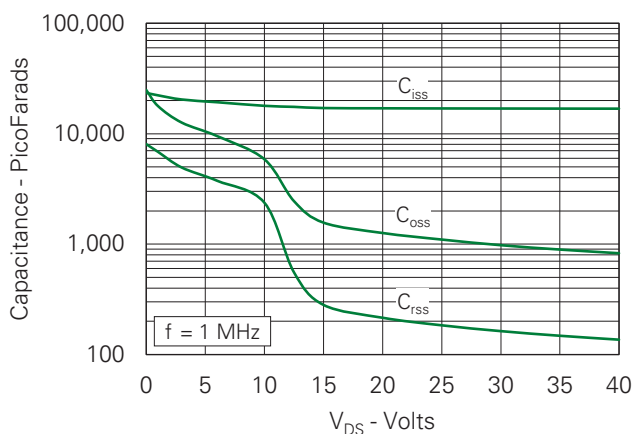
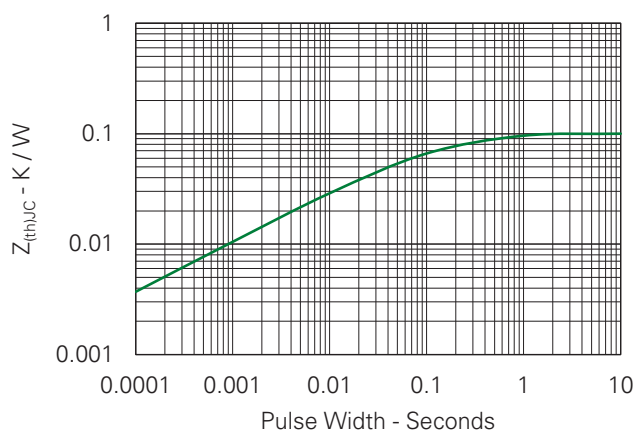
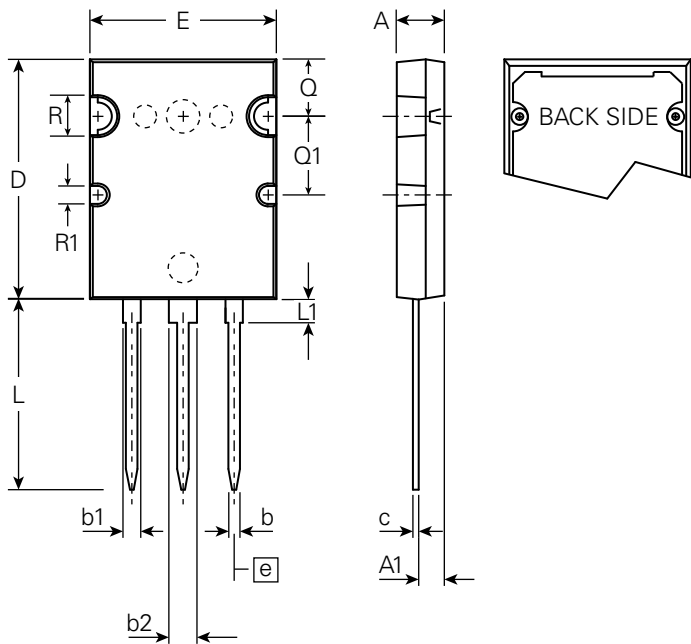


Fig. 12. Maximum Transient Thermal Impedance



Part Outline Drawing (PLUS TO-264)



Symbol	Inches			Millimeters		
	Min.	Typical	Max.	Min.	Typical	Max
A	0.185	–	0.209	4.70	–	5.31
A1	0.102	–	0.118	2.59	–	3.00
b	0.037	–	0.055	0.94	–	1.40
b1	0.087	–	0.102	2.21	–	2.59
b2	0.110	–	0.126	2.79	–	3.20
c	0.017	–	0.029	0.43	–	0.74
D	1.007	–	1.047	25.58	–	26.59
E	0.760	–	0.799	19.30	–	20.29
e	0.215 BSC			5.46 BSC		
L	0.779	–	0.842	19.79	–	21.39
L1	0.087	–	0.102	2.21	–	2.59
Q	0.240	–	0.256	6.10	–	6.50
Q1	0.330	–	0.346	8.38	–	8.79
ØR	0.155	–	0.187	3.94	–	4.75
ØR1	0.085	–	0.093	2.16	–	2.36

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